STRUCTURE	Silicon Monolithic Integrated Circuit
PRODUCT	CMOS Type series regulator
ТҮРЕ	BH28FB1WHFV
PACKAGE BLOCK TEST CIRCUIT APPRICATION CIRCU	5
FUTURES	 Output Voltage Accuracy 2.8V±1.0% Output Max Current 150mA Low Quiescence Current 40 µ A Stable With Ceramic output capacitor High Ripple Rejection Rate 70dB(f=1kHz) Over Current Protection Thermal Shutdown

- Output Control
 Package HVSOF5
- ABSOLUTE MAXIMUM RATINGS (Ta=25℃)

PARAMETER	Symbol	Limit	Unit	
Power Supply Voltage	VMAX	-0.3 ~ +6.5	V	
Power Dissipation	Pd	410 *1	mW	
Operating Temperature Range	Topr	-30 ~ +85	Ĉ	
Storage Temperature Range	Tstg	-55 ~ +125	Ĉ	

*1 Pd derated at 4.1mW/°C for temperature above Ta=25°C, mounted on $70 \times 70 \times 1.6$ mm glass-epoxy PCB.

RECOMMENDED OPERATING RANGE

PARAMETER	Symbol	Limit	Unit
Power Voltage	VIN	2.5~5.5	V
Output Max Current	IMAX	150	mA

PARAMETER	Symbol	the Limit			INIT	Conditions	
PARAMETER	Symbol	MIN.	TYP.	MAX.	UNIT	Conditions	
[REG]							
Output Voltage	VOUT	2.772	2.800	2.828	V	IOUT=1mA	
Circuit Current	I GND	-	40	70	μA	IOUT=50mA	
Circuit Current(STBY)	ISTBY	-	-	1.0	μA	STBY=0V	
Ripple Rejection Ratio	RR	-	70	-	dB	VRR=-20dBv, fRR=1kHz, IOUT=10mA	
Load Response 1	LTV1	-	50	- ,	mV	IOUT=1mA to 30mA	
Load Response 2	LTV2	-	50	-	mV	IOUT=30mA to 1mA	
Input.output voltage difference	VSAT	-	250	450	mV	VIN=0.98×VOUT,IOUT=100mA	
Line Regulation	VDL1	-	2	20	mV	VIN=3.3V to 5.5V, IOUT=50mA	
Load Regulation1	VDL01	-	10	30	mV	IOUT=1mA to 100mA	
Load Regulation2	VDL02	-	15	90	mV	IOUT=1mA to 150mA	
[OCP]							
Limit Current	ILMAX	-	250	-	mA	VIN=3.8V, Vo=VOUT×0.98	
Short Current	I SHORT	-	50	-	mA	VIN=3.8V, Vo=0V	
[STBY]							
STBY Pull-down Resistor	RSTB	550	1100	2200	kΩ		
STBY Control ON	VSTBH	1.5	-	VCC	V		
Voltage OFF	VSTBL	-0.3	-	0.3	V		

•ELECTRICAL CHARACTERSTICS (Ta=25°C, VIN=3.8V, STBY=1.5V, Cin=0.1 μ F, Co=1 μ F)

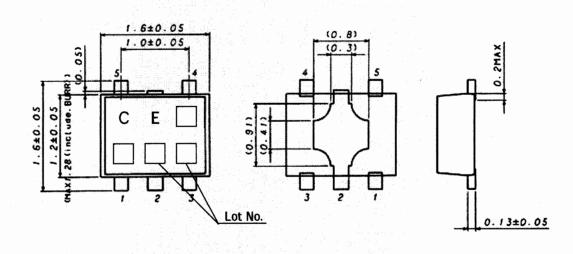
This product is not designed for protection against radio active rays.

•RECOMMENDED OPERATING CONDITION

PARAMETER	Symbol	MIN	ТҮР	MAX	UNIT	CONDITION
Input Capacitor	Cin	0.1	-	-	μF	Ceramic capacitor recommended
Output Capacitor	Со	1.0*2	2.2	-	μF	Ceramic capacitor recommended

%2 Recommended 2.2 μ F ceramic capacitor (All temperature range),

since an output may become unstable at the time of low temperature and light load. (Fig.24 Reference)



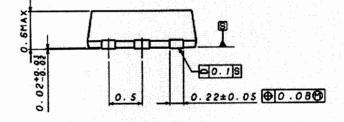


Fig.1 PACKEGE (Plastic Mold) (Unit:mm)

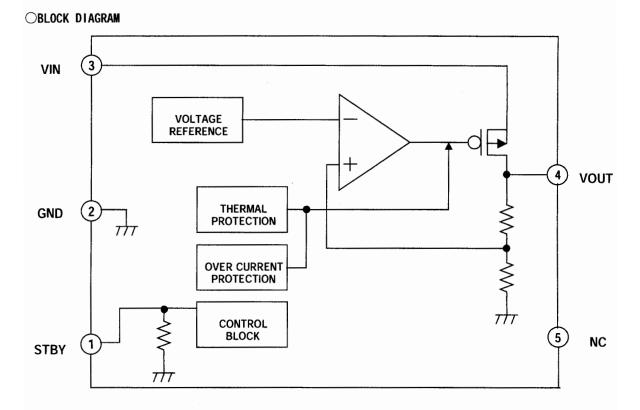


Fig.2 BLOCK DIAGRAM

OPIN DESCRIPTION

PIN No.	PIN Name	DESCRIPTION
1	STBY	OUTPUT CONTROL(High:ON,Low:OFF)
2	GND	GROUND Pin
3	VIN	INPUT Pin
4	VOUT	OUTPUT Pin
5	NC	NO CONNECT PIN

4/17

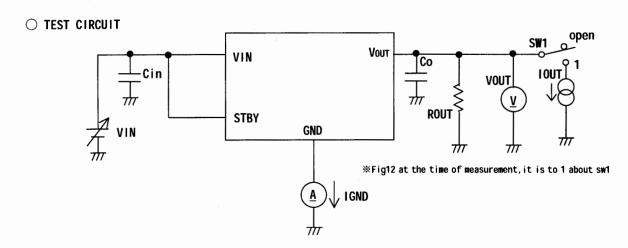


Fig.3 GND Current • Output Voltage Test Circuit (Characteristic example: Fig. 10~12, 21, 22)

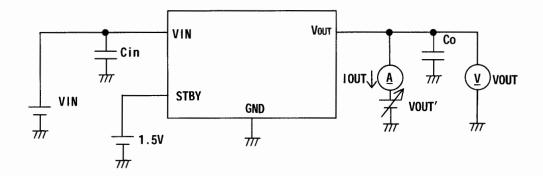


Fig.4 Over Current Protection Test Circuit (Characteristic example: Fig. 13)

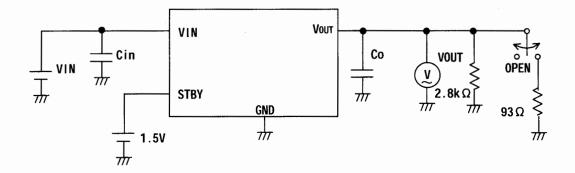


Fig.5 Load excessive response (Characteristic example : Fig.15~17)

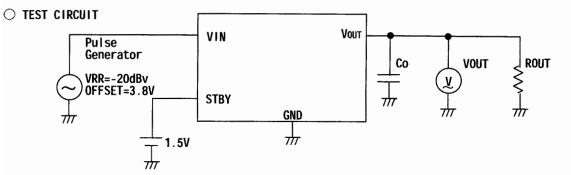


Fig.6 Ripple Rejection Ratio Test Circuit(Characteristic example : Fig. 18)

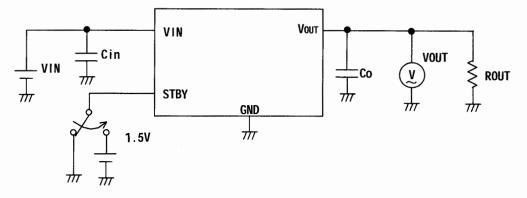


Fig.7 Output Voltage start-up time Test Circuit(Characteristic example : Fig. 19)

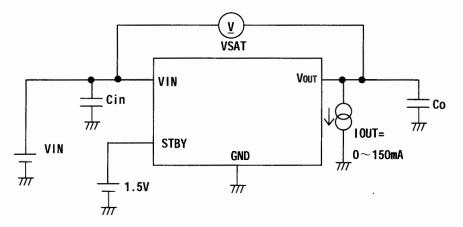
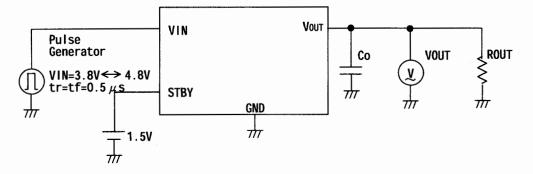
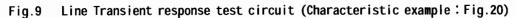
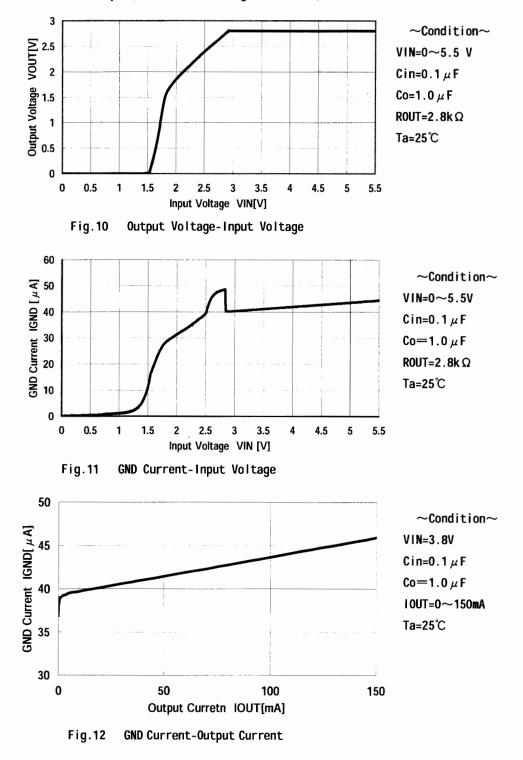


Fig.8 Input.output voltage difference Test Circuit (Characteristic example: Fig. 14)

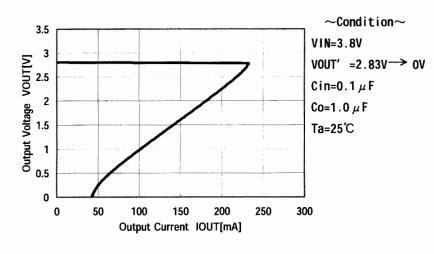






ODC Characteristic example(Reference: Package is SSOP5.)

8/17



○ DC Characteristic example(Reference: Package is SSOP5.)

Fig.13 Output Voltage-Output Current

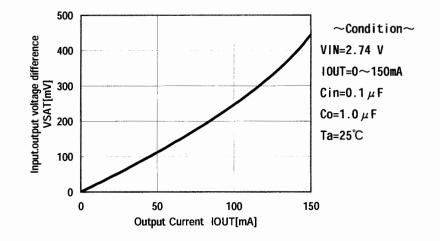
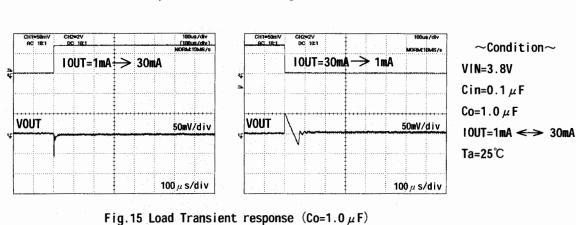
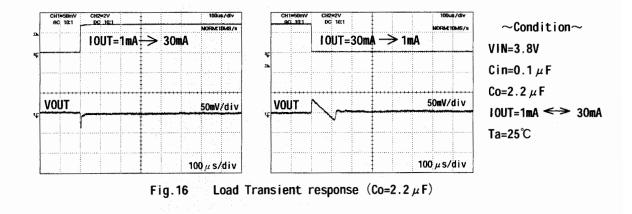
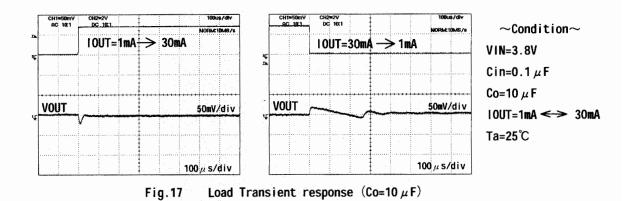


Fig.14 Input.output voltage difference-Output Current

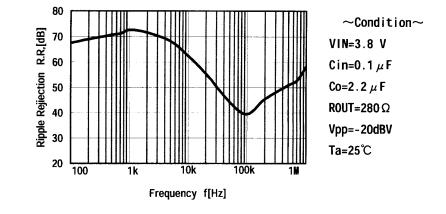
BH28FB1WHFV







OAC Characteristic example(Reference: Package is SSOP5.)



OAC Characteristic example(Reference: package is SSOP5.)



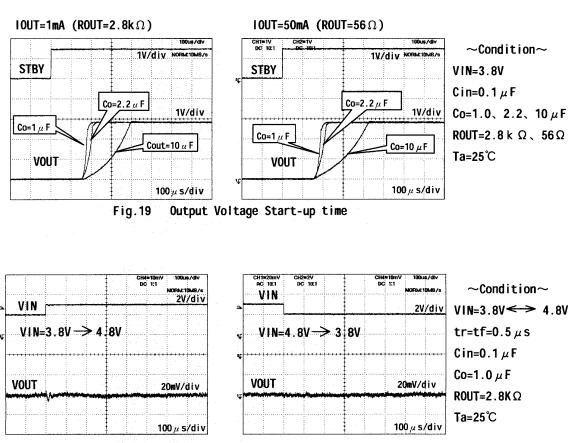
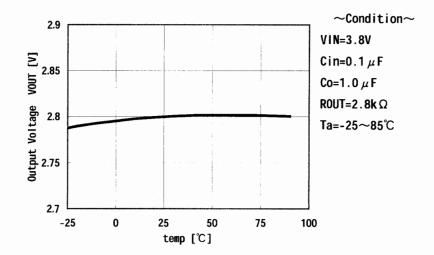


Fig.20 Line Transient response



OTemperature Characteristic example(Reference: package is SSOP5.)

Fig.21 Output Voltage- Temperature

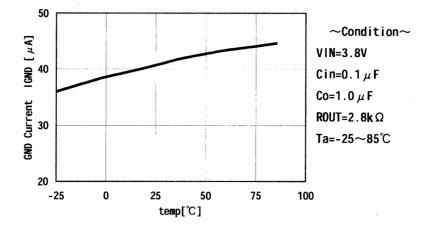
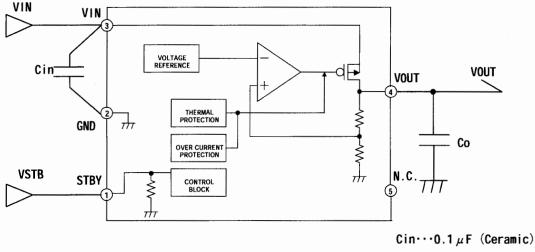


Fig.22 GND Current- Temperature

OApplication Circuit



 $Co\cdots 2.2 \mu F$ (Ceramic)

Fig.23 Application Circuit (Reference)

ℜ Note

The above application circuit is recommended for use. Make sure to confirm the adequacy of characteristics. When using the application circuit make sure to leave an adequate margin for external components, while considering static and transitional characteristics, as well as dispersion of the IC.

13/17

Operation Notes

1.)Absolute maximum ratings

This product is produced with strict quality control, however, may be destroyed if operated beyond its absolute maximum ratings.

If the device is destroyed by exceeding the recommended maximum ratings, the failure mode will be difficult to determine. (E.g. short mode, open mode)

Therefore, physical protection counter-measures (like fuse) should be implemented when operating conditions are beyond the absolute maximum ratings specified.

2.)GND potential

GND potential must be the lowest potential no matter what may happen. Actually, including transitional states, all pins except GND must not be the voltage below GND.

3.)Setting of heat

Consider Pd of actually using states, carry out the heat design which have adequate margin.

4.)Pin short and mistake fitting

When mounting the IC on the $\tilde{P}CB$, pay attention to the orientation of the IC. If there is a placement mistake, the IC may burn up.

5.)Actions in strong magnetic field

Using the IC within a strong magnetic field may cause a malfunction.

6.)Mutual impedance

Use short and wide wiring tracks for the power supply and ground to keep the mutual impedance as small as possible. Use a capacitor to keep ripple to a minimum.

7.)Voltage of STB pin

For standby mode set STB voltage below 0.3V. For normal operation set beyond 1.5V. The region Between 0.3V and 1.5V is not recommended and may cause improper operation.

8.) Over current protection circuit

Over current and short circuit protection is built-in at the output, and IC destruction is prevented at the time of load short circuit. These protection circuit is effective in the destructive prevention by the sudden accident, please avoid use to which a protection circuit operates continuously.

9.)Thermal shut-down

In cases of operation at high temperature thermal shut-down will be activated and output will be turned off. Once IC returns to its normal operating temperature, output will be turned back on.

 \bigcirc Operation Notes

10.)Output capacitor

To prevent oscillation at the output, it is recommended that the IC be operated at the stable region shown in Fig.24. (When the output capacitor is $1.0 \,\mu$ F output may become unstable at low temperature and light load.) Output capacitor value above $2.2 \,\mu$ F have shown stable output operation over a wide temperature range under varying load conditions.

Cout=1.0 µF Temp=-25℃

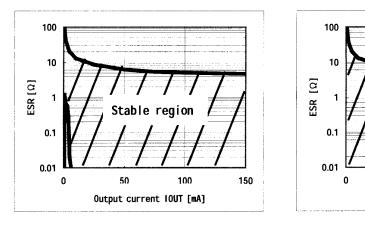
Cout=2.2 µF Temp=-25℃

Stable region

Output current IOUT [mA]

100

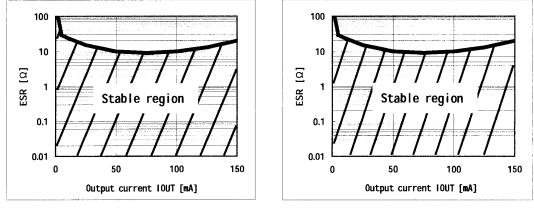
150

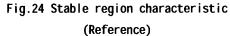






50

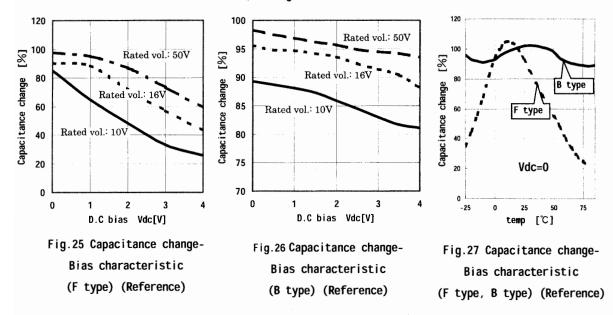




○ Operation Notes

11.) Input capacitor

It is recommended that a 0.1μ F bypass capacitor be placed between VIN and GND. Consider mounting of the capacitor such that lead lengths are as short as possible. Ceramic capacitors, in general, exhibit the best characteristics for stability against changing temperature and increasing DC bias voltage. Specifically, ceramic capacitors that are B type and have a high voltage rating exhibit the best characteristic. (See Figures below for reference.)



○ Operation Notes

12.) Regarding input pin of the IC

This is a monolithic IC which has a P+ substrate and a P isolation between each pin. A P-N junction is formed from this P layer at each pin.

For example the relation between each potential is as follows,

(When GND > PinB and GND > PinA, the P-N junction operates as a parasitic diode.) (When PinB > GND > PinA, the P-N junction operates as a parasitic transistor.) Parasitic diodes can occur inevitably in the IC structure. The operation of parasitic diodes can result in mutual interference among circuits as well as operation faults and physical damage. Accordingly, you must not use methods by which parasitic diodes operate, such as applying a voltage that is lower than the GND (P substrate) voltage to an input pin.

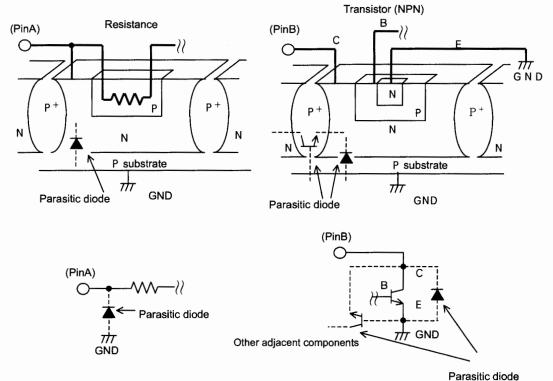


Fig.28 Simplified structure of a Monolithic IC

Notes

- No technical content pages of this document may be reproduced in any form or transmitted by any means without prior permission of ROHM CO.,LTD.
- The contents described herein are subject to change without notice. The specifications for the product described in this document are for reference only. Upon actual use, therefore, please request that specifications to be separately delivered.
- Application circuit diagrams and circuit constants contained herein are shown as examples of standard use and operation. Please pay careful attention to the peripheral conditions when designing circuits and deciding upon circuit constants in the set.
- Any data, including, but not limited to application circuit diagrams information, described herein are intended only as illustrations of such devices and not as the specifications for such devices. ROHM CO.,LTD. disclaims any warranty that any use of such devices shall be free from infringement of any third party's intellectual property rights or other proprietary rights, and further, assumes no liability of whatsoever nature in the event of any such infringement, or arising from or connected with or related to the use of such devices.
- Upon the sale of any such devices, other than for buyer's right to use such devices itself, resell or
 otherwise dispose of the same, no express or implied right or license to practice or commercially
 exploit any intellectual property rights or other proprietary rights owned or controlled by
- ROHM CO., LTD. is granted to any such buyer.
- Products listed in this document are no antiradiation design.

The products listed in this document are designed to be used with ordinary electronic equipment or devices (such as audio visual equipment, office-automation equipment, communications devices, electrical appliances and electronic toys).

Should you intend to use these products with equipment or devices which require an extremely high level of reliability and the malfunction of with would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), please be sure to consult with our sales representative in advance.

About Export Control Order in Japan

Products described herein are the objects of controlled goods in Annex 1 (Item 16) of Export Trade Control Order in Japan.

In case of export from Japan, please confirm if it applies to "objective" criteria or an "informed" (by MITI clause) on the basis of "catch all controls for Non-Proliferation of Weapons of Mass Destruction.

rohm